

Product data sheet

1. General description

Dual ultrafast power diode in a SOT78 (TO-220AB) plastic package.

2. Features and benefits

- Fast switching
- Low thermal resistance
- High thermal cycling performance
- Low forward voltage drop
- Reverse surge capability
- Soft recovery characteristic

3. Applications

• Output rectifiers in high-frequency switched-mode power supplies

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions Values				Unit	
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		200				
I _{O(AV)}	average output current	δ = 0.5; square-wave pulse; T _{mb} ≤ 104 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u>	16			A	
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 104 °C; square-wave pulse; per diode	16			A	
I _{FSM} non-repetitive peak forward current		t_p = 10 ms; sine-wave pulse; per diode $T_{j(init)}$ = 25 °C	80		A		
		t_p = 8.3 ms; sine-wave pulse; per diode $T_{j(init)}$ = 25 °C	88		A		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics	·					
V _F	forward voltage	$I_F = 8 \text{ A}; T_j = 150 \text{ °C}; Fig. 4$ - 0.84 0.95		0.95	V		
Dynamic	characteristics	·					
t _{rr}	reverse recovery time	$I_R = 1 \text{ A}; I_F = 0.5 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ step recovery; } Fig. 6$		-	12	22	ns

5. Pinning information

Pin	Pinning infor Symbol	Description	Simplified outline	Graphic symbol		
1	A1	anode 1	mb			
2	К	cathode				
3	A2	anode 2				
mb	К	mounting base; cathode		K sym125		

6. Ordering information

Table 3. Ordering inform	nation					
Type number	Package					
	Name	Description	Version			
BYQ30E-200	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			

7. Marking

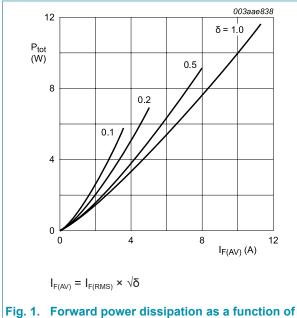
Table 4. Marking codes						
Type number	Marking codes					
BYQ30E-200	BYQ30E-200					

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		200	V
V_{RWM}	crest working reverse voltage		200	V
V _R	reverse voltage	DC	200	V
I _{O(AV)}	average output current	$δ = 0.5$; square-wave pulse; $T_{mb} \le 104$ °C; both diodes conducting; Fig. 1; Fig. 2	16	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 104 °C; square-wave pulse; per diode	16	A
I _{FSM}	non-repetitive peak forward current	$t_p = 10 \text{ ms}; \text{ sine-wave pulse}; \text{ per diode} T_{j(init)} = 25 \text{ °C}$	80	A
		t_p = 8.3 ms; sine-wave pulse; per diode $T_{j(init)}$ = 25 °C	88	A
I _{RRM}	repetitive peak reverse current	$δ = 0.001; t_p = 2 μs$	0.2	A
I _{RSM}	non-repetitive peak reverse current	t _p = 100 μs	0.2	A
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C
Electrostat	tic discharge		·	
V_{ESD}	electrostatic discharge voltage	HBM; all pins; C = 250 pF; R = 1.5 k Ω	8	kV



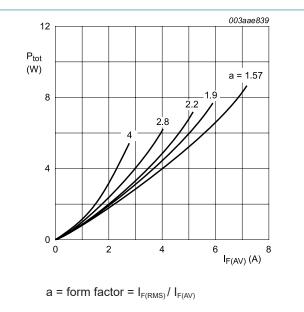


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

	average forward current; square waveform; maximum values

9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to	with heatsink compound; both diodes conducting; <u>Fig. 3</u>	-	-	2.5	K/W
	mounting base	with heatsink compound; per diode; <u>Fig. 3</u>	-	-	3	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient		-	60	-	K/W

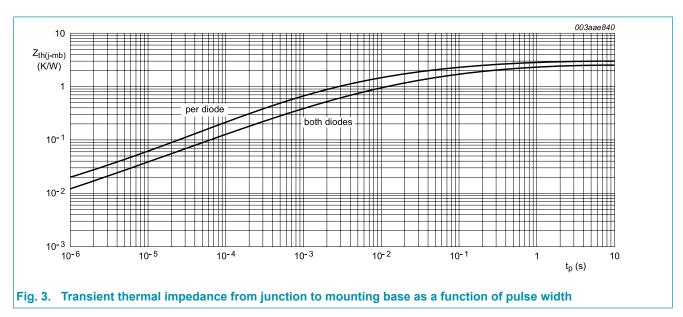
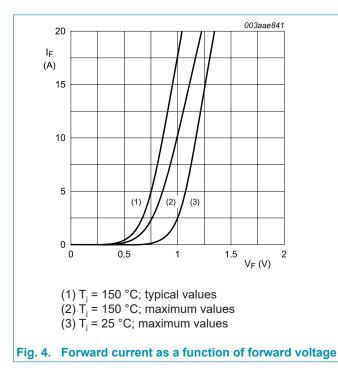
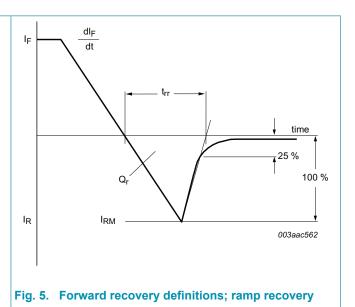


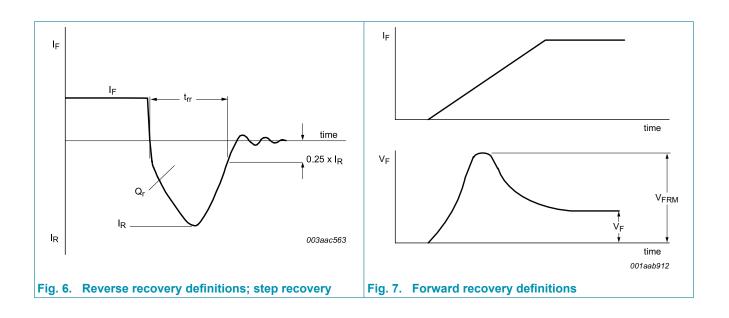
Table 6 Thermal characteristics

10. Characteristics

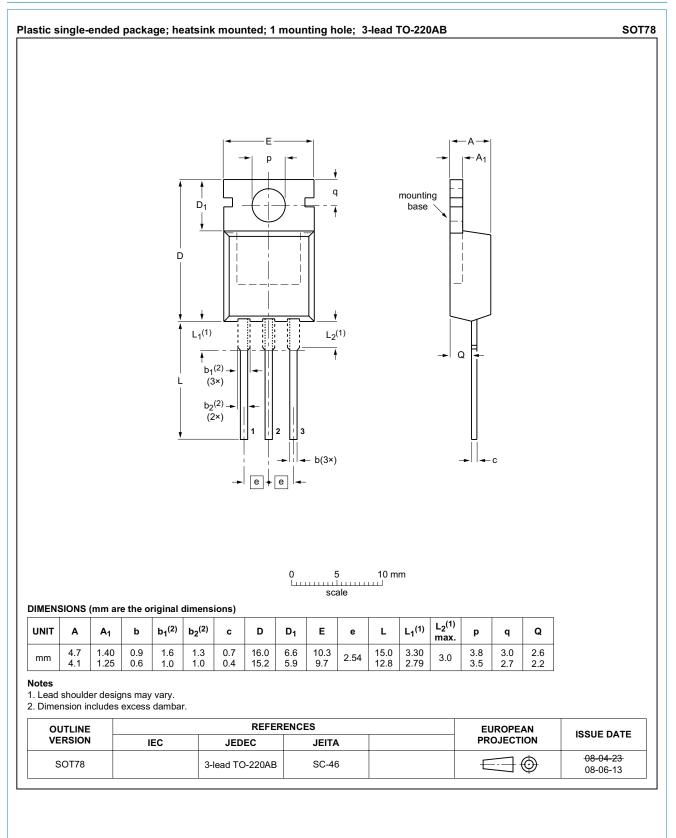
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _F	forward voltage	I _F = 16 A; T _j = 150 °C; <u>Fig. 4</u>	-	1	1.15	V
		I _F = 16 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.12	1.25	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 4</u>	-	0.84	0.95	V
I _R	reverse current	V _R = 200 V; T _j = 25 °C	-	4	30	μA
		V _R = 200 V; T _j = 100 °C	-	0.3	0.6	mA
Dynamic	characteristics		· · · · ·			
Q _r	recovered charge	$I_F = 2 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 20 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 5$	-	4	11	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; ramp recovery; $T_j = 25 \text{ °C}$; Fig. 5	-	20	25	ns
		I _F = 0.5 A; I _R = 1 A; step recovery; I _{R(meas)} = 0.25 A; T _j = 25 °C; <u>Fig. 6</u>	-	12	22	ns
V_{FR}	forward recovery voltage	I _F = 1 A; dI _F /dt = 10 A/μs; T _j = 25 °C; <u>Fig. 7</u>	-	1	-	V







11. Package outline



12. Revision history

Table 8. Revision hist	ory						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
BYQ30E-200 v.5	20180605	Product data sheet	-	BYQ30E-200 v.4			
Modifications: Change from NXP version to WeEn version							
BYQ30E-200 v.4	20100901	Product data sheet	-	BYQ30E_SERIES_3			
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Type number BYQ30E-200 separated from datasheet BYQ30E_SERIES. 						
BYQ30E_SERIES_3	19981001	Product specification	-	BYQ30E_SERIES_2			

BYQ30E-200

Dual ultrafast power diode

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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